

## 不同倍率大靶面物镜自动对焦规格

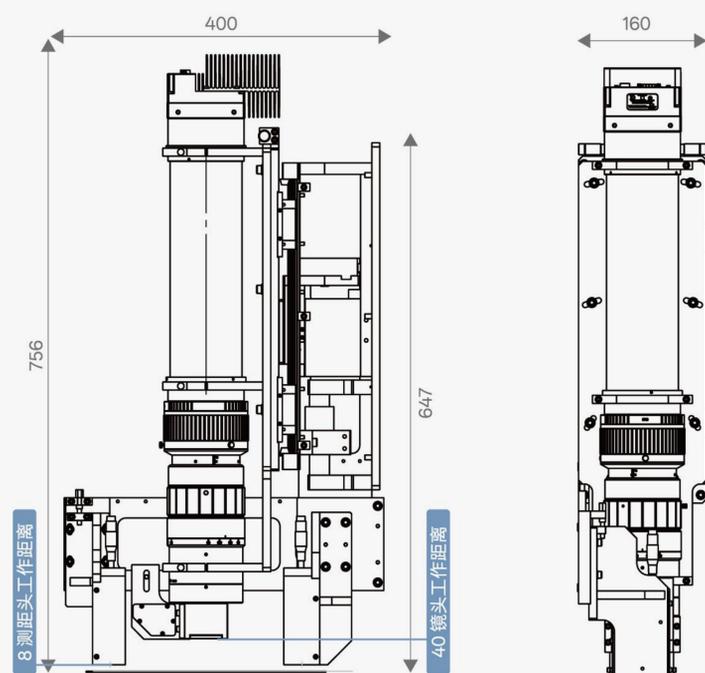
Autofocus specifications for large-format objectives with different magnifications

倍率 MAGNIFICATION	像素精度um PIXEL PRECISION	视野范围mm FIELD OF VISION	景深um DEPTH OF FIELD	物像距mm DEPTH OF FIELD	扫描速率mm/s SCAN RATE
2.5	2	32.77	27.59	570	600
3.33	1.5	24.60	16.68	665.1	450
5	1	16.38	7.69	697.89	300

# 大靶面物镜 自动对焦系统

## 规格图

DIMENSION DRAWING



电话(Tel): +86 755-2955 3446

邮箱(E-mail): market@dzoptycs.com

网址(Web): www.dzoptycs.com

总部地址: 深圳市龙岗区宝龙街道翠宝路32号新屋吓工业园3栋1层

ADD: 1/F., Building 3, Xinwuxia Industrial Park, No. 32, Cuibao Road, Baolong Street, Longgang District, Shenzhen, China

深圳市东正光学技术股份有限公司  
Shenzhen Dongzheng Optical Technology Co., Ltd.



公众号/DZOPTICS

官网/Website



Large-Surface  
Objective Lens  
Autofocus System

# 大靶面物镜自动对焦系统

LARGE-SURFACE OBJECTIVE LENS AUTOFOCUS SYSTEM

## Features and Advantages

### 特点优势

采用线激光对焦技术，结合高分辨率编码器实现对焦精度±1μm，响应时间低于100ms

Line laser focusing technology is adopted, combined with a high-resolution encoder, to achieve a focusing accuracy of ±1μm and a response time of less than 100ms.

专为大靶面高精度视觉检测设计，适用于无图案/有图案晶圆面板及IC载板检测

Designed specifically for high-precision visual inspection of large-surface objectives, suitable for the inspection of patterned/unpatterned wafers, panels, and IC substrates.

支持16K超大靶面相机与高行频扫描，确保复杂表面条件下依然稳定快速对焦，全面提升检测效率与可靠性

Supports a 16K ultra-large objective lens camera and high line frequency scanning, ensuring stable and fast focusing even under complex surface conditions, comprehensively improving inspection efficiency and reliability, customizable to customer needs.



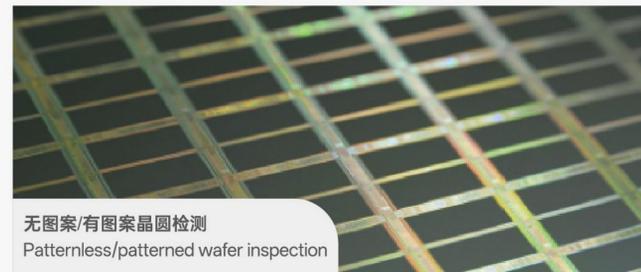
# 规格

SPECIFICATION

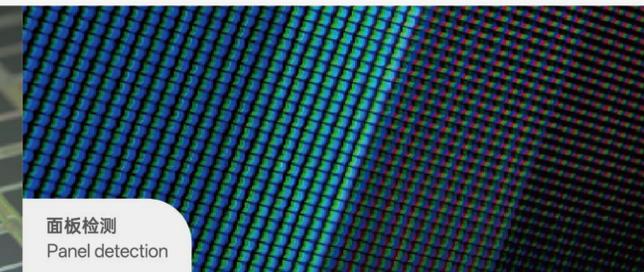
项目 ITEM	参数 PARAMETER
对焦行程/时间 FOCUSING TRAVEL/TIME	± 0.5mm/<100ms
对焦精度 FOCUSING ACCURACY	1/4倍景深 1/4 DEPTH OF FIELD
电机动作频率 MOTOR OPERATING FREQUENCY	40Hz
测距相机计算频率 RANGING CAMERA CALCULATION FREQUENCY	330Hz
编码器分辨率 ENCODER RESOLUTION	0.1μm
电机定位精度 MOTOR POSITIONING ACCURACY	± 1μm
电机行程 MOTOR STROKE	10mm
Z轴最大负载 MAXIMUM LOAD ON THE Z-AXIS	22kg
仪器重量 INSTRUMENT WEIGHT	30kg
仪器尺寸(mm) INSTRUMENT DIMENSIONS (MM)	L:495*W795*H:255

## 应用场景

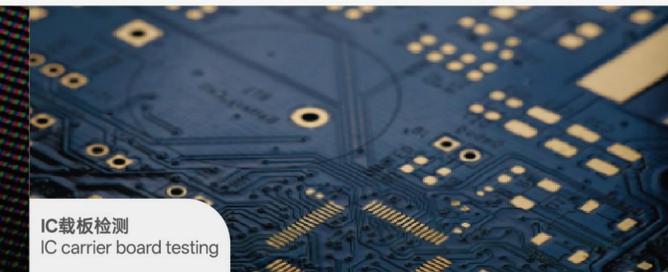
APPLICATION



无图案/有图案晶圆检测  
Patternless/patterned wafer inspection



面板检测  
Panel detection



IC载板检测  
IC carrier board testing